LEADTEK COMPANY LIMITED

Preliminary Specification
Approval Specification

SPECIFICATION FOR LCD MODULE

Customer :	
Product Model:	LTK104P3009JCX
Sample code:	

Designed by	Checked by	Approved by

Final Approval by Customer

Approved by	Comment

^{**}The specification of "TBD" should refer to the measured value of sample . If there is difference between the design specification and measured value, we naturally shall negotiate and agree to solution with customer.

Revision History

Version	Contents	Data	Note
		Date	Note
V0	First issue	2021.07.26	
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1. Scope

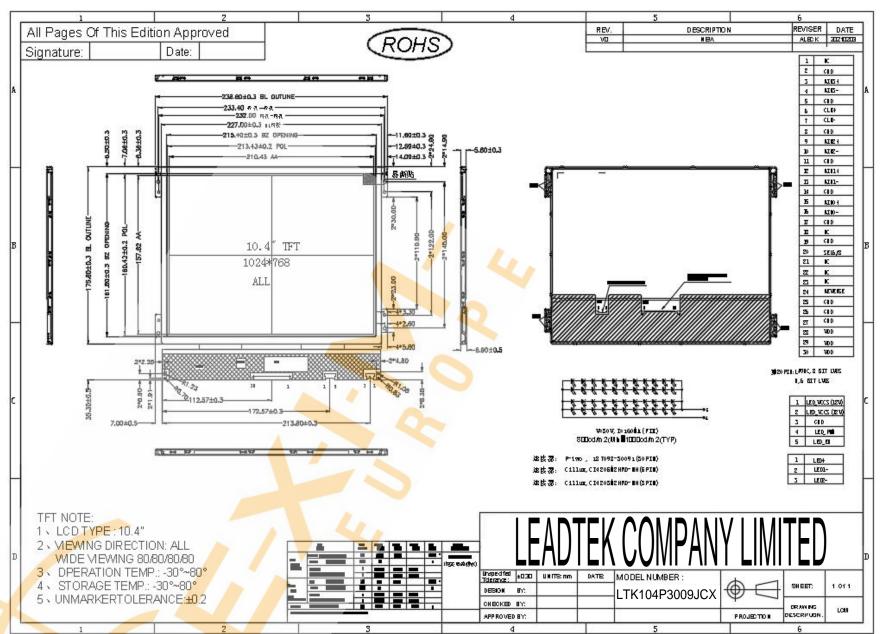
This specification defines general provisions as well as inspection standards for TFT module supplied by LEADTEK.

If the event of unforeseen problem or unspecified items may occur, naturally shall negotiate and agree to solution

2. General Information

ITEM	STANDARD VALUES	UNITS	
LCD type	pe 10.4"TFT		
Dot arrangement	1024×R.G.B.×768	dots	
Color filter array	RGB vertical st <mark>ripe</mark>	-	
Display mode	Normally Black	-	
Viewing Direction	80/80/80/80		
Module size	size 238.6(W)×175.8(H)×5.75(T)		
Active area	210.432(W)×157.824(H)	mm	
Dot pitch	0.2055(W)×0.2055(H)	mm	
Interface	LVDS 6/8 bit		
Operating temperature	-30 ~ +80	°C	
Storage temperature	-30 ~ +80	°C	
Weight	TBD	g	

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External Dimensions

3

4.1 TFT Interface Description

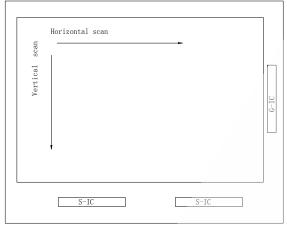
PIN	PIN NAME	DESCRIPTION	Remark
1	NC	Reserved as BIST function for INX test	Note 1
2	GND	Ground	
3	RIN 3+	Positive LVDS differential data input (+)	
4	RIN 3-	Negative LVDS differential data input (-)	
5	GND	Ground	
6	CLK+	Positive LVDS differential data input (+)	
7	CLK-	Negative LVDS differential data input (-)	
8	GND	Ground	
9	RIN 2+	Positive LVDS differential data input (+)	
10	RIN 2-	Negative LVDS differential data input (-)	
11	GND	Ground	Q
12	RIN 1+	Positive LVDS differential data input (+)	
13	RIN 1-	Negative LVDS differential data input (-)	
14	GND	Ground	
15	RIN0 +	Positive LVDS differential data input (+)	
16	RIN0 -	Negative LVDS differential data input (-)	
17	GND	Ground	
18	NC	No connection	
19	GND	Ground	
20	SEL6/8	Selection for 6 bits/8bit LVDS data input Low or NC : 8 bit input mode High : 6 bit input mode	Note 2
21	NC	Reversed as EE_WP for OTP function	Note 3
22	NC	Reversed as EE_SDA for OTP function	Note 3
23	NC	Reversed as EE_SCL for OTP function	Note 3
24	REVERSE	Reverse panel function (Display rotation)	Note 4
25- <mark>2</mark> 7	GND	Ground	
28-30	VDD	Power supply: + 3.3V	

Connector:Input LVDS CONN,30pins, P-two, 187098-30091

Note:

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- 1. Pin1 is reversed as BIST function for test, don't connect signal to this pin, keep floating.
- 2. SEL6/8 is used for selecting 6bit/8bit LVDS data input, L or NC: 8bit; High:6bit.
- 3. Pin21,22,23 are used as SPI interface for OTP function, don't connect any signal to these pin, and don't short them, keep floating.
- 4. Reverse pin is used for selecting scanning direction.



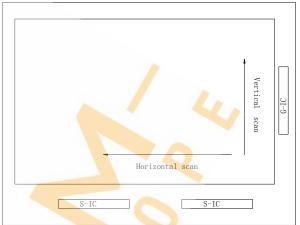


Fig. 1 Normal scan (Pin24, Reverse = Low or NC) Fig. 2 Reverse scan (Pin24, Reverse = High)

4.2 BL converter power IC Description

PIN	PIN NAME	DESCRIPTION
1	LED_VCCS	12V input
2	LED_VCCS	12V input
3	GND	Ground
4	LED_PWM	PWM
5		C <mark>onvert</mark> er power IC Enable (Active High)

Connector:Input BL power CONN,5pins, Cillux,CI4205M2HRD-NH

4.3 BL Description

PIN	PIN NAME	DESCRIPTION
1	LED+	Red wire
2	LED1-	White wire
3	LED2-	White wire

Connector: Output BL power CONN, 3pins, Cillux, CI4203M2HRD-NH

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5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit	Remark
Digital Supply Voltage	VDD	-0.3	4.0	V	
VIN Voltage	VLED	-0.3	50	V	
Operating Temperature	Тор	-30	80	°C	
Storage Temperature	Тѕт	-30	80	°C	

6. DC Characteristics

6.1 Parameter

Item	Symphol		Values			Remark
item	Symbol	Min.	. Тур. Мах.		Unit	Remark
Dawar voltage	VDD	3.0	3.3	3.6	V	
Power voltage	LED_VCCS	11	12	13	V	
Input logic high voltage	V _{IH}	0.7VDD	,	VDD	V	1
Input logic low voltage	V _{IL}	0	7-	0.3VDD	V	
	I _{VDD}		385	424	mA	VDD =3.3V@frame 60 Hz, White pattern
Current for Power	I _{LED_VCCS}	- 1	0.52	7	Α	100% PWM Duty @ VLED+ =33V, ILED=80mA*2
LED EN Control Lovel	BL On	3.0	-	5	V	
LED_EN Control Level	BL Off	0	To .	0.3	V	
LED_PWM Control	PWM High Level	3.0	-	5	V	
Level	PWM Low Level	0	7.	0.3	V	
LED_PWM Control Frequency	f _{PWM}	1K	=	20K	Hz	2

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Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Digital Supply Voltage	VDD	2.75	3.3	3.6	V	
VIN Voltage	LED_VCCS	-0.3	-	25	V	
Input logic high voltage	VIH	0.7*VDD	-	VDD	V	
Input logic low voltage	VIL	GND	-	0.3*VDD	V	

Note 1: Including signal: SEL6/8 & Reverse

Note 2: LED_PWM duty >10%.

6.2 BL power output

			Values			
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Voltage for LED backlight	V_{led}	27.0	30.0	33.0	V	1
Current for LED backlight	${ m I}_{ m led}$		160	4	mA	2

Note 1: output power LED+ OVP is 40V.

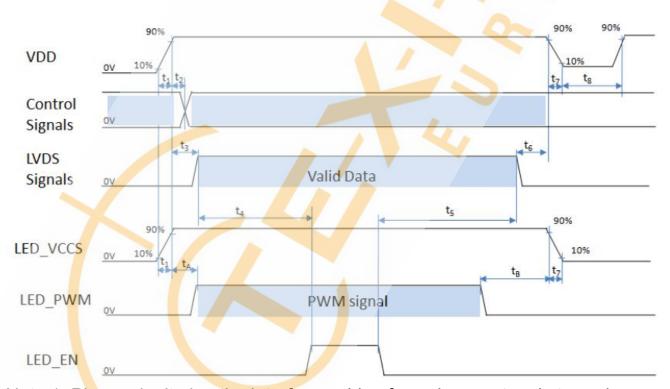
Note 2: Set BL feedback 2 channels, each channel feedback current is 80mA

6.3 Power sequence

The power sequence specifications are shown as the following table and diagram.

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Symbol	Va	lue	Linit	
	Min.	Max.	Unit	
t ₁	1	20	ms	
t ₂	1	5	ms	
t ₃	10	50	ms	
t 4	200	500	ms	
t ₅	200	500	ms	
t ₆	50	200	ms	
t ₇	0	20	ms	
t ₈	500	-	ms	
t _A	0	50	ms	
t _B	0	50	ms	



Note 1: Please don't plug the interface cable of on when system is turned on. Note 2: Please avoid floating state of the interface signal during signal invalid period.

Note 3: It is recommended that the backlight power must be turned on after the power supply for LCD and the interface signal is valid.

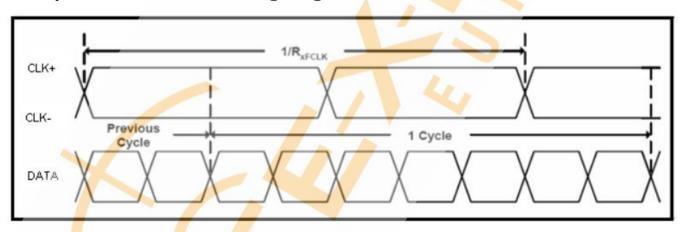
Note 4: Control signals include SEL6/8 & Reverse.

7. LVDS SIGNAL TIMING CHARACTERISTICS

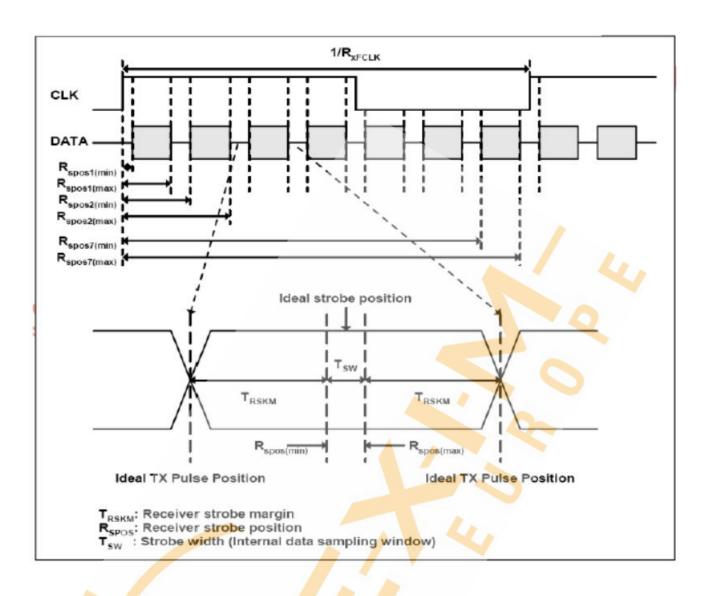
7.1AC Electrical characteristics

Parameter	Symbol	Min	Тур	Max	Unit s	Condition
Clock frequency	RxFCLK	26.2	51.2	71	MHz	
Input data skew margin	TRSKM	500	500	1/(2*RxFCLK)	ps	Typical value for 1024*600 resolution
Clock high time	TLVCH		4/(7xRxFCLK)		ns	VID =400mv RxVCM=1.2V RxFCLK=71MHz VDD_LVDS=3.3V
Clock low time	TLVCL		3/(7xRxFCLK)		ns	4
VSD setup time	TenPLL	0	TenPLL	150	us	5

7.2 Input clock and data timing diagram

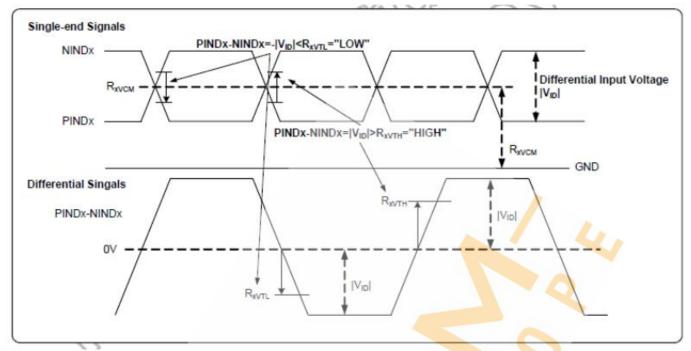


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7.3 DC electrical characteristics

Down to	0 1 1	Values			11-14	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Remark
LVDS Di <mark>ffe</mark> rential input <mark>hig</mark> h Threshold voltage	R _{xVTH}	-	=	+100	mV	D -1 0\/
LVDS Differential input low Threshold voltage	R _{xVTL}	-100	-	-	mV	R _{XVCM} =1.2V
Input Voltage range (Singled-end)	R _{xVIN}	0		VDD-1.2+ V _{ID} /2	V	
LVDS Differential input common mode voltage	R _{xVCM}	V _{ID} /2	-	VDD-1.2	٧	
LVDS Differential voltage	V _{ID}	0.2	856	0.6	V	

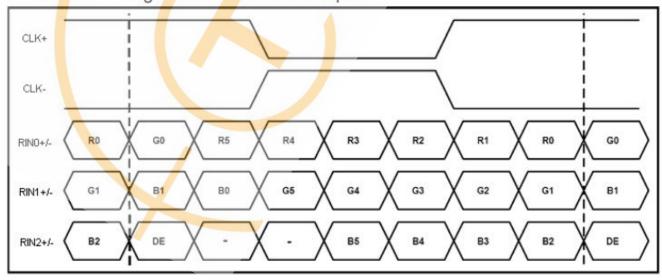


7.4 data timing

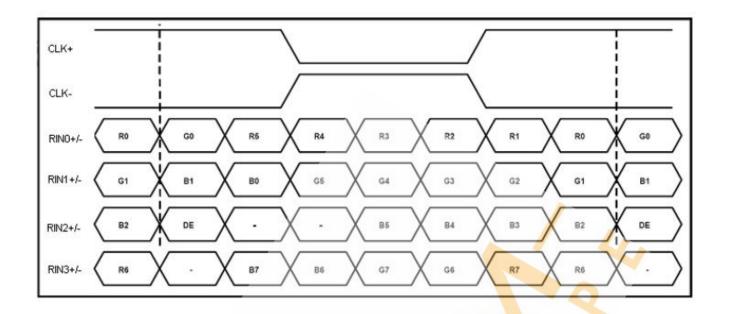
Parameter	Symbol		Unit		
Falailletei	Symbol	Min.	Тур.	Max.	Offic
DCLK frequency	fclk	52	65	71	MHz
Horizontal display area	thd		1024		DCLK
HSD period	th	1114	1344	1400	DCLK
HSD blanking	thb+thfp	90	320	376	DCLK
Vertical display area	tvd		768		T _H
VSD period	tv	778	806	845	T _H
VSD blanking	tvbp+tvfp	10	38	(5/77)	T _H

7.5 LVDS data input format

SEL6/8 = "High" for 6 bits LVDS Input



SEL6/8 = "Low" or "NC" for 8 bits LVDS Input



8. Backlight Characteristic

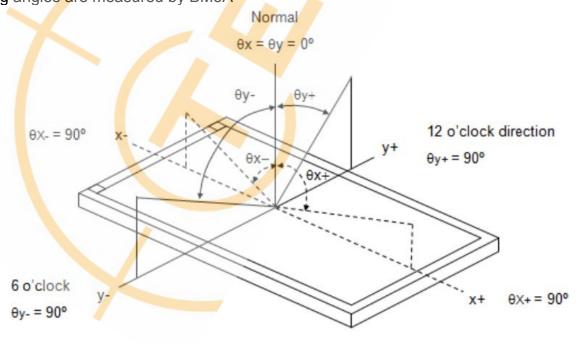
Item		Symbol	MIN	TYP	MAX	UNIT	NOTE
Backlight Pow	er	LED_VCCS	-0.3	12	25	V	Ta = 25°C
Backlight Pow	er	ILED_VCCS	-	0.5	0.8	Α	LED_VCCS=12V
EN Signal Volta	VIH	LED EN	3.0		5.0	V	
ge	VIL	LED_EN	GND		0.3	V	
Luminous Intensi	VIH	1 ED DW/M	3.0		5.0	V	
for LCM	VIL	LED_PWM	GND		0.3	V	
PWM Frequen	су	LED_PWM	1K	-	20K	Hz	
Lifetime			50000	-	-	Hr	
Color				٧	/hite		
Average Brightn	ess	-	800 🛕	1000	-	Cd/cm2	
Luminance unifor	rmity	-	75	-	-	%	

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9. Optical Characteristics

Item	Conditions		Min.	Тур.	Max.	Unit	Note	
	Horizontal	θL	80	-	-			
Viewing Angle	Honzontai	θR	80	-	-	dograa	(4)	
(CR>10)	Vertical	θт	80	_	-	degree	(1)	
	Vertical	θв	80	_	-			
Contrast Ratio	Center		700	1000	-	-	(2)	
Response Time	Rising			14	19	ms	(3)	
	Falling		_	11	16	ms		
	Red x			0.651		-/	41	
	Red y			0.345		-		
	Green x			0.315		-	Q	
CF Color	Green y			0.611		-	(4)	
Chromaticity (CIE1931)	Blue x		TYP. -0.05	0.145	TYP.	- ((4)	
	Blue y	Blue y		0.093	+0.05	-		
	White x			0.326		0		
	White y			0.383				

Note (1)Definition of Viewing Angle (θx , θy): Viewing angles are measured by BM5A



Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

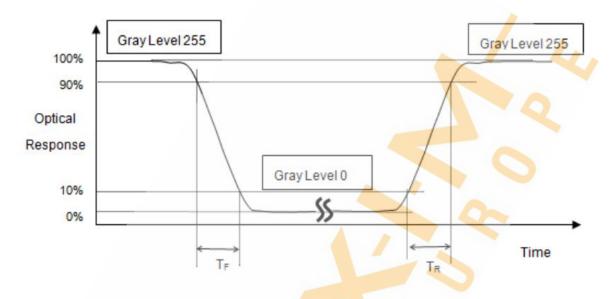
Contrast Ratio (CR) = L255 / L0

L255: Luminance of gray level 255

L 0: Luminance of gray level 0

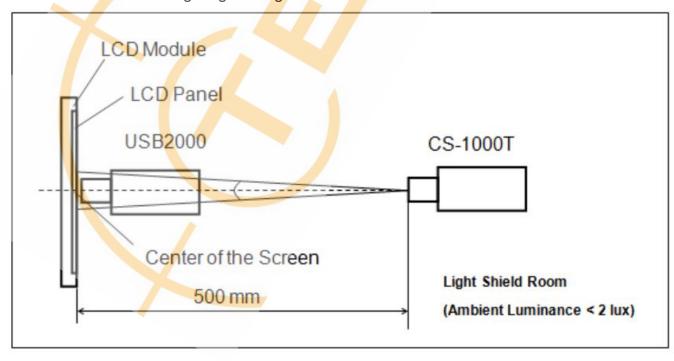
CR = CR (5), where CR (X) is corresponding to the Contrast Ratio of the point X at the figure in

Note (3) Definition of Response Time (TR, TF):



Note (4)Measurement Setup:

The LCD assembly should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a windless room.



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10. Reliability Test Conditions and Methods

NO.	TEST ITEMS	TEST CONDITION
1)	High Temperature Storage	Keep in 80°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
2	Low Temperature Storage	Keep in -30°C ±5°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
3	High Temperature Operating Test	80°C*96Hrs
4	Low Temperature Operating Test	-30℃*96Hrs
5	High Temperature / High Humidity Operating Test	60 ℃ / 90% R.H ,96 hrs.
6	High Temperature / High Humidity Storage Test	Keep in 60 °C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
7	Temperature Cycling Storage Test	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$
	\times	Air Discharge: Apply 6 KV with 5 times Discharge for each polarity +/- Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/-
8	ESD Test	 Temperature ambiance: 15°C~35°C Humidity relative: 30%~60% Energy Storage Capacitance(Cs + Cd): 150pF±10% Discharge Resistance(Rd): 330Ω±10% Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: ±5%)
9	Vi <mark>brat</mark> ion Test (Pac <mark>ka</mark> ged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm Each direction (X、Y、Z) duration for 2 Hrs

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			Packing Weight (Kg)	Drop Height (cm)			
			0 ~ 454	122			
100	Drop Test		45.4 ~ 90.8	76			
10	(Packaged)		90.8 ~ 454	61			
			Over 454	46			
		Drop					
		Direction	: 1 corner / 3 edges / 6 sides each 1 time				

11. Inspection Standard

11.1. QUALITY:

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

11.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM AMSON TO PURCHASER. PURCHASER SHALL CONTROL THE LCM AT -10 TO 40 ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

11.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION, A SAMPLING PLAN SHALL BE APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (SAME AS MIL-STD-105E), LEVEL: II

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION, A LOT OUT IS DISCOVERED. PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT WITHIN FOURTEEN DAYS.

11.1.3. WARRANTY POLICY

AMSON WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION OPERATING CONDITIONS. AMSON WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCTS WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF AMSON.

11.2. CHECKING CONDITION

11.2.1.CHECKING DIRECTION SHALL BE IN THE 45 DEGREE AREA TO FACE THE SAMPLE.

11.2.2.CHECKER SHALL SEE OVER 300±25 mm. WITH BARE EYES FAR FROM SAMPLE Ambient Illumination:

Functional detection in 600nits backlight environment Appearance detection in 800~1000 Lux external environment

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11.3. INSPECTION PLAN:

CLASS	ITEM	JUDGEMENT	CLASS
PACKING &	OUTSIDE AND INSIDE PACKAGE	"MODEL NO.", "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
INDICATE	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXEDREJECTED QUANTITY SHORT OR OVERREJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREAREJECTED	Minor
	6. BLEMISH - BLACK SPOT - WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
APPEARANCE	7. BLEMISH - BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION(INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCDREJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
7	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST. VOP. CHROMATICITY ETC.)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
ELECTRICAL	11.MISSING LINE	MISSING DOT: LINE : CHARACTERREJECTED	Critical
	12.SHORT CIRCUIT WRONG PATTERN DISPLAY	NO DISPLAY - WRONG PATTERN DISPLAY - CURRENT CONSUMPTION OUT OF SPECIFICATION REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT) ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor

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NO.	CLASS	ITEM	JUDGEMENT
11.4.1	MINOR	BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH SCRATCH	(A) ROUND TYPE: unit : mm.
			DIAMETER (mm.) ACCEPTABLE Q'TY
			Φ ≤ 0.15 Distance≥1mm
			0.15 < Φ ≤ 0.4 3 (Distance>15mm)
			0.4 < Φ 0
			NOTE: Φ=(LENGTH+WIDTH)/2
			(B) LINEAR TYPE: unit : mm.
			LENGTH WIDTH ACCEPTABLE Q'TY
			W ≦0.03 Distance≥1mm
			L ≤ 4.0 0.03 < W ≤ 0.05 3 (Distance>15mm)
			0.05 < W FOLLOW ROUND TYPE
	MINOR	BUBBLE IN POLARIZER DENT ON POLARIZER	DIAMETER ACCEPTABLE Q'TY
			Φ ≤ 0.2 Distance≥1mm
1142			0.2 < Φ ≤ 0.5 3 (Distance>15mm)
11.7.2			0.5 < Φ 0
			0.5 < Φ
			0
_		· · · · · · · · · · · · · · · · · · ·	
		Dot Defect	Items ACC. Q'TY
11.4.3			Bright dot N≦2 (Distance≥15mm)
			Dark dot N≤3 (Distance>15mm)
			Pixel Define: 1. Pixel
			Pixel Define:
			R G B
	MINOR		◆ Dot → ◆ Dot →
			Note 1: The definition of dot: The size of a defective dot over
			1/2 of whole dot is regarded as one defective dot.
1			Definittion:<1/2dot and visible by 5% ND filter N≤5
			Note 2: Bright dot: Dots appear bright and unchanged in size
			in which LCD panel is displaying under black pattern.
			Note 3: Dark dot: Dots appear dark and unchanged in size in
			530
			which LCD panel is displaying under pure red, green
			,blue pattern.
11,4,4	MINOR	Mura	Not visible thriugh 5% ND filter in 50% gray or judge
			by limit sample if necessary

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NO.	CLASS	ITEM	JUDGEMENT
11.4.5	MINOR	LCD GLASS CHIPPING	X ≥ 3mm Y > S Reject
11.4.6	MINOR	LCD GLASS CHIPPING	X or Y > S Reject
11.4.7	MAJOR	LCD GLASS GLASS CRACK	Continuous burst NG Reject
11.4.8	MAJOR	LCD GLASS SCRIBE DEFECT	ACCORDING TO DIMENSION
11.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	Y<1/2Z Y ≥ 0.5mm _{Reject} X ≥ 3mm
11.4.10	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	Y<1/2Z $Y \ge 0.5 \text{mm}$ $X \ge 3 \text{mm}$
11.4.11	MINOR	LCD GLASS CHIPPING	$X\geqslant 3mm$ $Y\geqslant T\qquad \text{Reject}$ $Z\qquad \text{If touch the electrode lines,}$ the need to retain the two-thirds electrode lines

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12. Handling Precautions

12.1 Mounting method

The LCD panel of JINGCHUANGXING TFT module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[Recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (CI), Sulfur (S)

If goods were sent without being silicon coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Sulfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Power or Ground, do not input any signals before power is turned on, and ground your body, work/assembly areas, and assembly equipment to protect against static electricity.

12.4 packing

- Module employs LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- Slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.

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12.6 storing

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it. And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution for Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported to JINGCHUANGXING TFT, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

TBD

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